

RoHS COMPLIANT

HALOGEN

FREE

1

**Vishay Siliconix** 

### P-Channel 30 V (D-S) MOSFET

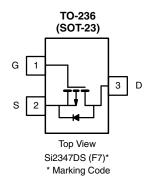
MOSFET PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
	0.042 at V <sub>GS</sub> = - 10 V	- 5			
- 30	0.054 at V <sub>GS</sub> = - 6 V	- 4.4	6.9 nC		
	0.068 at V <sub>GS</sub> = - 4.5 V	- 3.9			

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



- Load Switch
- Notebook Adaptor Switch
- DC/DC Converter
- Power Management



Ordering Information: Si2347DS-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (TA	= 25 °C, unless oth	nerwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 30	V		
Gate-Source Voltage	V <sub>GS</sub>	± 20	v		
	T <sub>C</sub> = 25 °C		- 5		
Continuous Drain Current ( $T_{I}$ = 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	- 4	A	
	T <sub>A</sub> = 25 °C		- 3.8 <sup>b,c</sup>		
	T <sub>A</sub> = 70 °C		- 3 <sup>b,c</sup>		
Pulsed Drain Current (t = 300 µs)	I <sub>DM</sub> - 2	- 20			
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	la	- 1.4		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 0.63 <sup>b,c</sup>		
	T <sub>C</sub> = 25 °C		1.7		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	PD	1.1	w	
	T <sub>A</sub> = 25 °C	' D	1.20 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		0.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	≤ 5 s	R <sub>thJA</sub>	100	130	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	60	75	0/11		

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 175 °C/W.

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### Si2347DS

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					1	1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 25		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		3.9			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 1		- 2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	1	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = - 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			- 10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS}$ $\leq$ - 5 V, $V_{GS}$ = - 10 V	- 20			Α	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3.8 A		0.033	0.042		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 6 V, I <sub>D</sub> = - 3.3 A		0.041	0.054	Ω	
		$V_{GS} = -4.5 \text{ V}, I_{D} = -3 \text{ A}$		0.050	0.068		
Forward Transconductance <sup>a</sup> $g_{fs}$ $V_{DS} = -5 V, I_D = -3.8 A$			10		S		
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			705		1	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		93		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	20 20		73			
·		V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		14.5	22	- nC	
Total Gate Charge	Qg	20 20 2		6.9	10.4		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 15 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 5 A		2.3			
Gate-Drain Charge	Q <sub>gd</sub>			2.1			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	1.7	8.3	17	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			6	12		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 5 $\Omega$		6	12	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	${\rm I}_{\rm D}$ = - 3 A, ${\rm V}_{\rm GEN}$ = - 10 V, ${\rm R}_{\rm G}$ = 1 $\Omega$		19	29		
Fall Time	t <sub>f</sub>			9	18		
Turn-On Delay Time	t <sub>d(on)</sub>			10	20		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 5 $\Omega$		9	18	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	${\rm I}_{\rm D}$ = - 3 A, ${\rm V}_{\rm GEN}$ = - 6 V, ${\rm R}_{\rm G}$ = 1 $\Omega$		18	27		
Fall Time	t <sub>f</sub>			7	14		
Drain-Source Body Diode Characteristi	cs				1		
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 1.4	٨	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			1	- 20	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			13	20	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			5	10	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F$ = - 3 A, dl/dt = 100 A/µs, $T_J$ = 25 °C		7			
Reverse Recovery Rise Time	t <sub>b</sub>			6		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

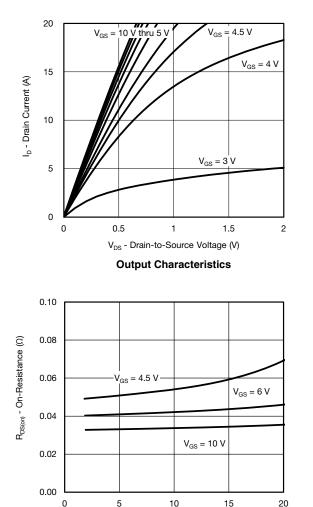
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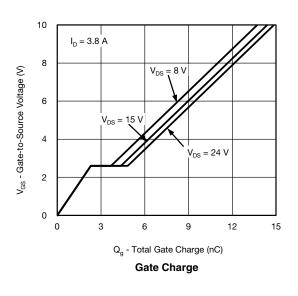
### Si2347DS Vishay Siliconix

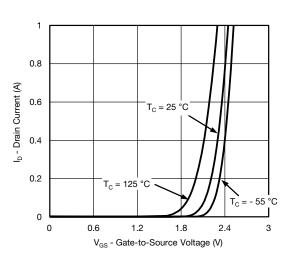
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



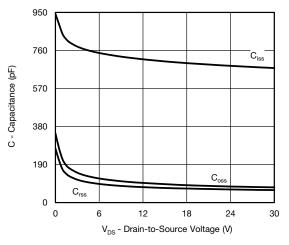
On-Resistance vs. Drain Current and Gate Voltage

I<sub>D</sub> - Drain Current (A)

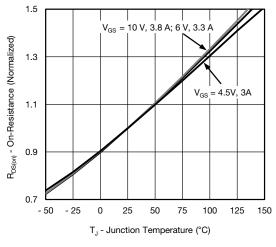




**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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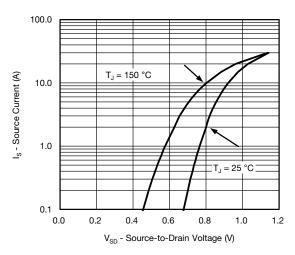
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### Si2347DS

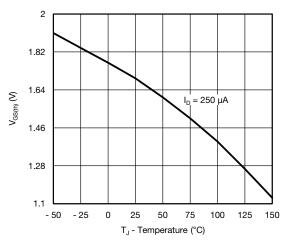




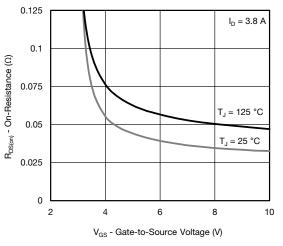
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



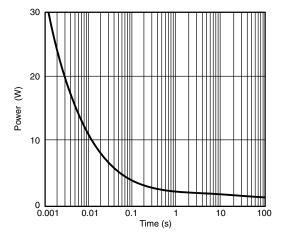
Source-Drain Diode Forward Voltage



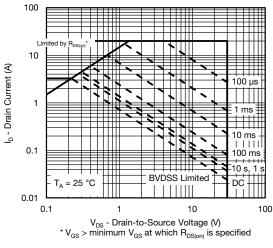
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage







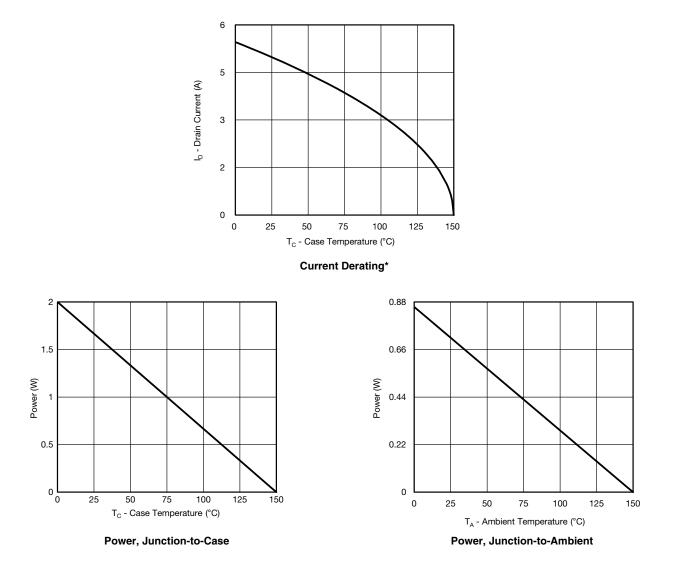
Safe Operating Area

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

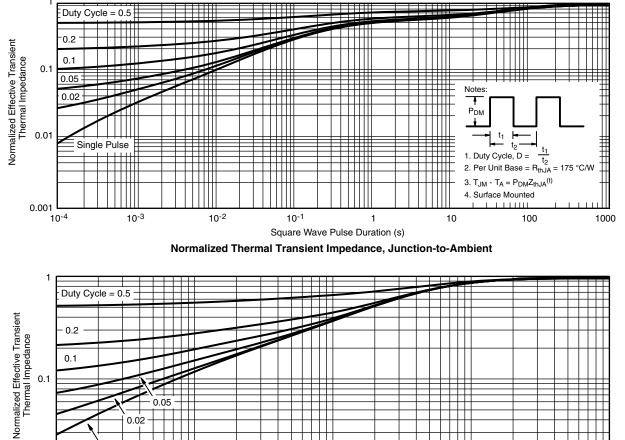


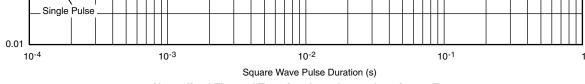
\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?62827">www.vishay.com/ppg?62827</a>.

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## Package Information

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#### SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES			
	Min	Max	Min	Мах		
Α	0.89	1.12	0.035	0.044		
A <sub>1</sub>	0.01	0.10	0.0004	0.004		
A <sub>2</sub>	0.88	1.02	0.0346	0.040		
b	0.35	0.50	0.014	0.020		
С	0.085	0.18	0.003	0.007		
D	2.80	3.04	0.110	0.120		
E	2.10	2.64	0.083	0.104		
E <sub>1</sub>	1.20	1.40	0.047	0.055		
е	0.95 BSC		0.0374 Ref			
e <sub>1</sub>	1.90	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024		
L <sub>1</sub>	0.64 Ref		0.025 Ref			
S	0.50 Ref		0.020	0.020 Ref		
q	3°	8°	3°	8°		



# Application Note 826

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#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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